AP100505-ATC3

SMD Type Amber Emitter

Features

- Top view 0402 package
- Viewing Angle = $\pm 60^{\circ}$
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Ultra bright Amber
- RoHS compliance

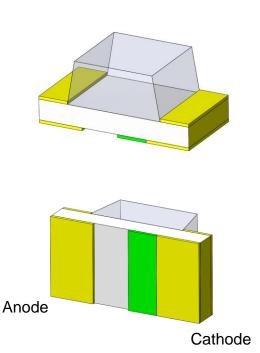
Applications

- Optical indicator.
- Switch and Symbol Display.

Description

The AP100505-ATC3 is an AllnGaP Amber LED housed in a miniature SMD package. The device has a dominant wavelength of 605nm LED.

Package Outline



Schematic





Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
lF	Continuous Forward Current	25	mA	
IFP	Peak Forward Current	60	mA	1
VR	Reverse Voltage	5	V	
Topr	Operating Temperature	-40 ~ +85	٥C	
T _{stg}	Storage Temperature	-40 ~ +100	٥C	
T _{sol}	Soldering Temperature	260	0C	2
PD	Power Dissipation at(or below) 25°C Free Air Temperature	65	mW	

Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

Optical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I _F =20mA	74	-	200	mcd	3
λD	Dominant Wavelength	I _F =20mA	600	-	610	nm	4
θ1/2	Angle of Half Intensity	I _F =20mA	-	±60	-	deg	

Electrical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I _F =20mA	1.7	-	2.5	V	5
IR	Reverse Current	V _R =5V	-	-	1	μA	

Notes:

1. IFP Conditions--Pulse Width $\leq~100\mu s$ and Duty $\leq~10\%.$

2. Soldering time ≤ 10 seconds.



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3. Bin Range of Luminous Intensity

Bin Code	Min	Max	Unit	Condition
m2	74	89		
n1	89	100		
n2	100	130	mcd	I _F =20mA
01	130	160		
o2	160	200		

Tolerance of: Luminous Intensity $\pm 10\%$

4. Bin Range of Dominant Wavelength

Bin Code	Min	Max	Unit	Condition
J1	600	605		1
J2	605	610	nm	l⊧=20mA

Tolerance of Dominant Wavelength: ±1nm.

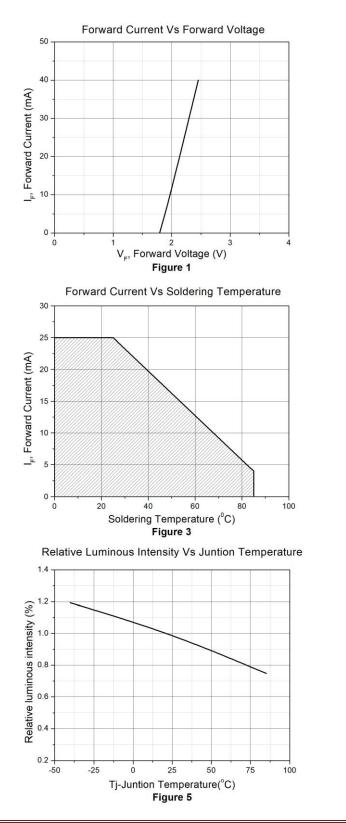
5. Bin Range of Forward Voltage

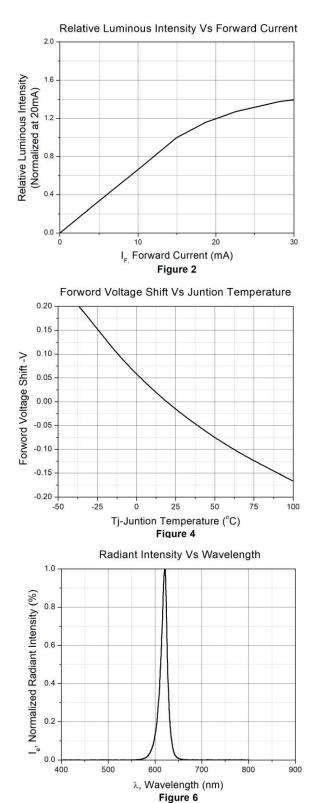
Bin Code	Min	Max	Unit	Condition
V4	1.7	1.9		
V5	1.9	2.1	V	
V6	2.1	2.3	v	l⊧=20mA
V7	2.3	2.5		

Tolerance of Forward Voltage ± 0.1 V.



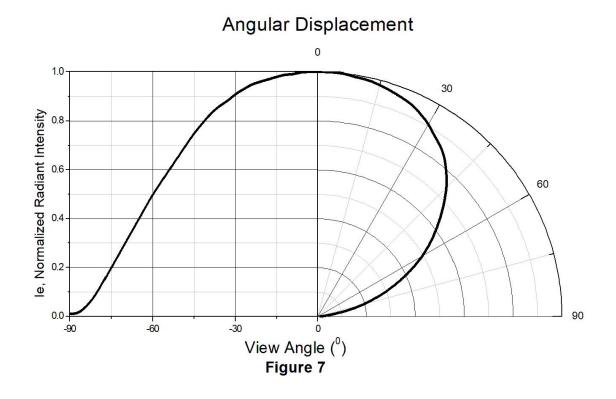
Typical Characteristic Curves



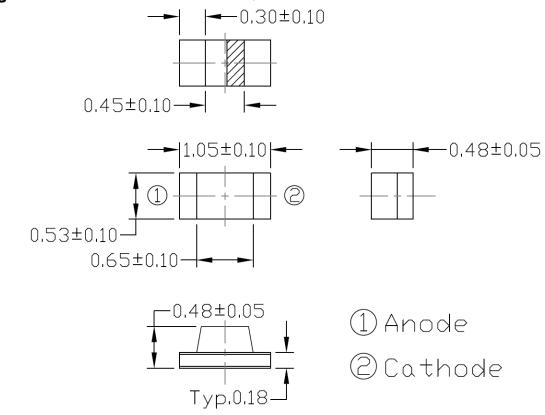




Typical Characteristic Curves



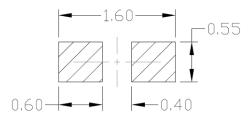




Package Dimension All dimensions are in mm, unless otherwise stated

Note: Tolerance unless mentioned is ±0.1mm.

Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



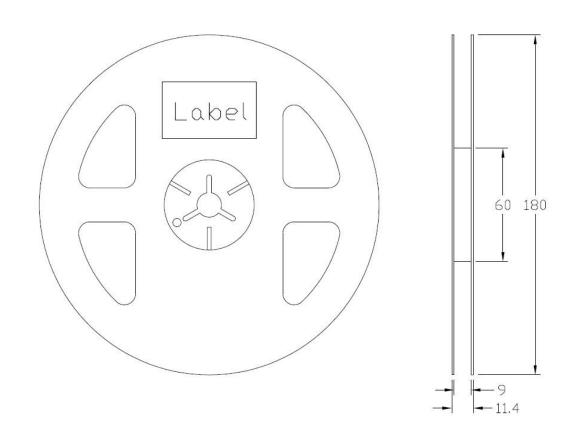
Note: Tolerance unless mentioned is ± 0.1 mm.

Ordering Information

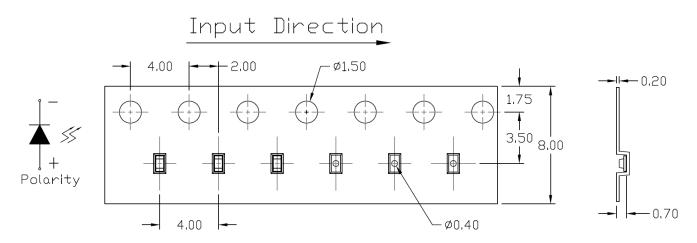
Part Number	Description	Quantity
AP100505-ATC3	Tape & Reel	3000 pcs



Reel Dimension All dimensions are in mm, unless otherwise stated



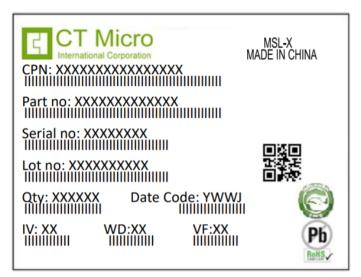
Tape Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.



Label Form Specification



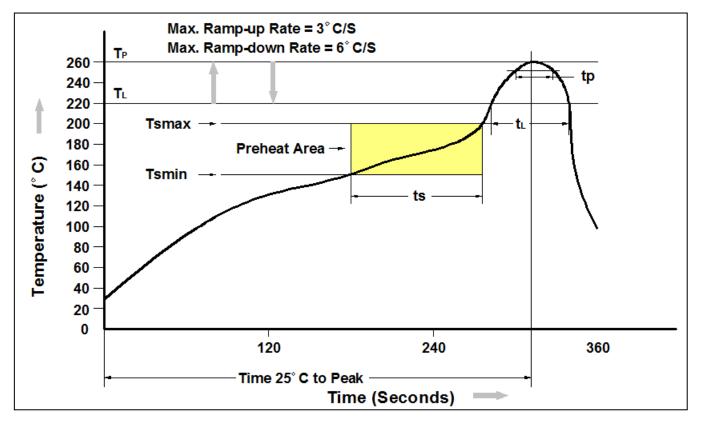
CPN : Customer Part Number Part no: CTM Production Number Serial no: Production Number Lot no: Lot number Q'ty: Packing Quantity Date Code: Manufacture Date IV : Bin Code of Luminous Intensity WD : Bin Code of Dominant Wavelength VF : Bin Code of Forward Voltage MADE IN CHINA: Production Place

Storage Condition

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 1 year at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t _P)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T_P to T_L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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